AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Serial Number: 10/628,594 Filing Date: July 28, 2003

Title: METHOD FOR MANUFACTURING AN INTERCONNECTED CIRCUIT BOARD ASSEMBLY AND SYSTEM

Assignee: Intel Corporation

IN THE SPECIFICATION

Please amend the specification as follows:

The paragraph beginning at page 1, after the title, is amended as follows:

This application is a divisional of U.S. Patent Application Serial No. 09/750,444, filed December 28, 2000, now issued as U.S. Patent No. 6,621,168, which is incorporated herein by reference.